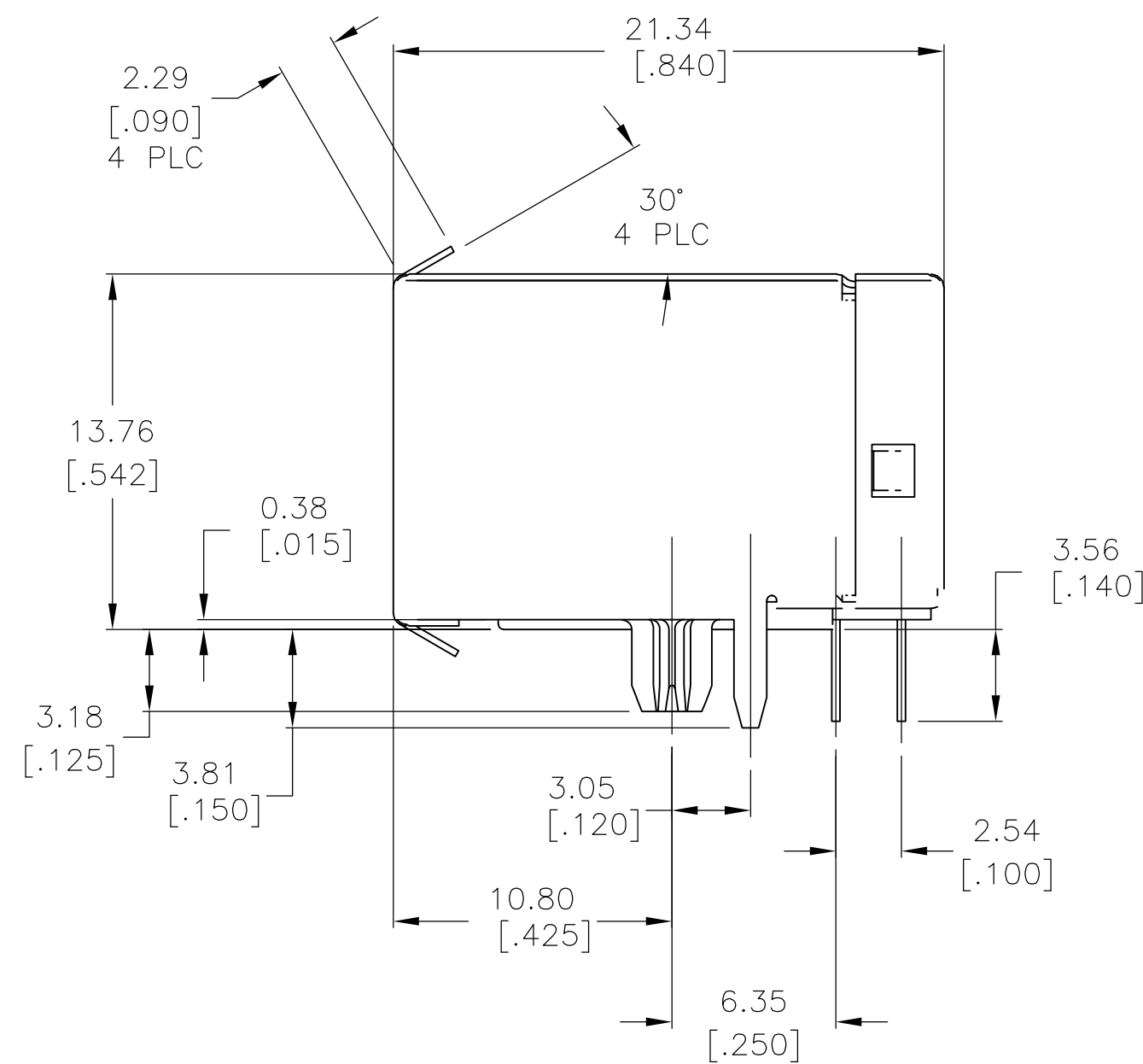
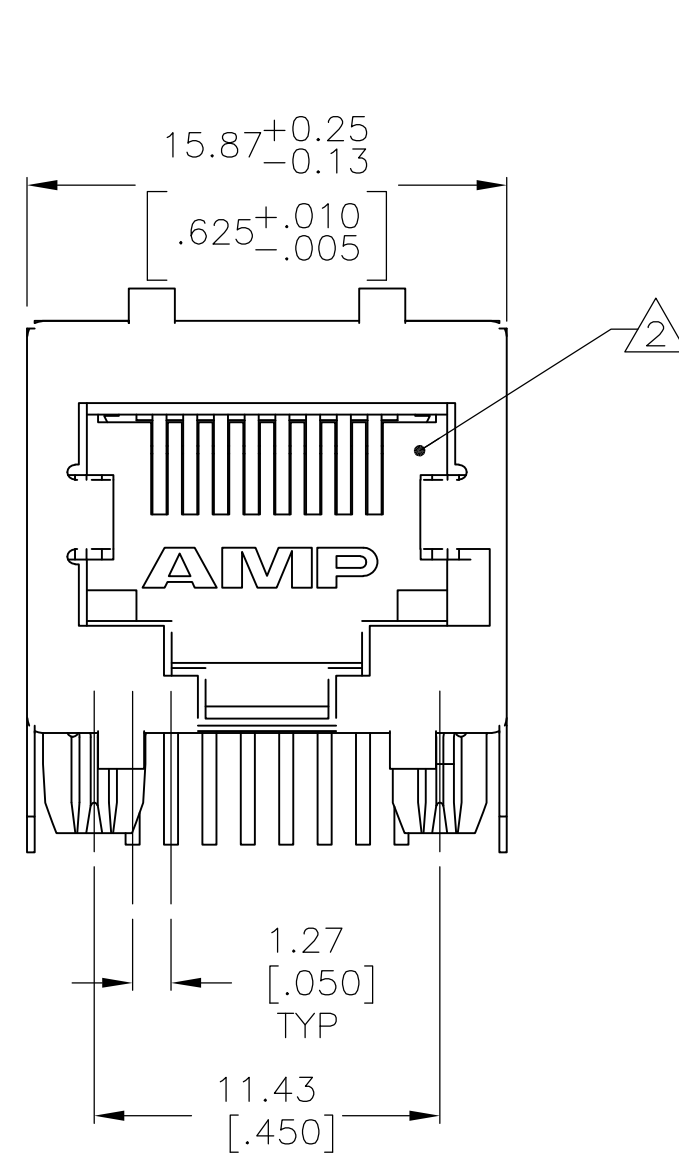
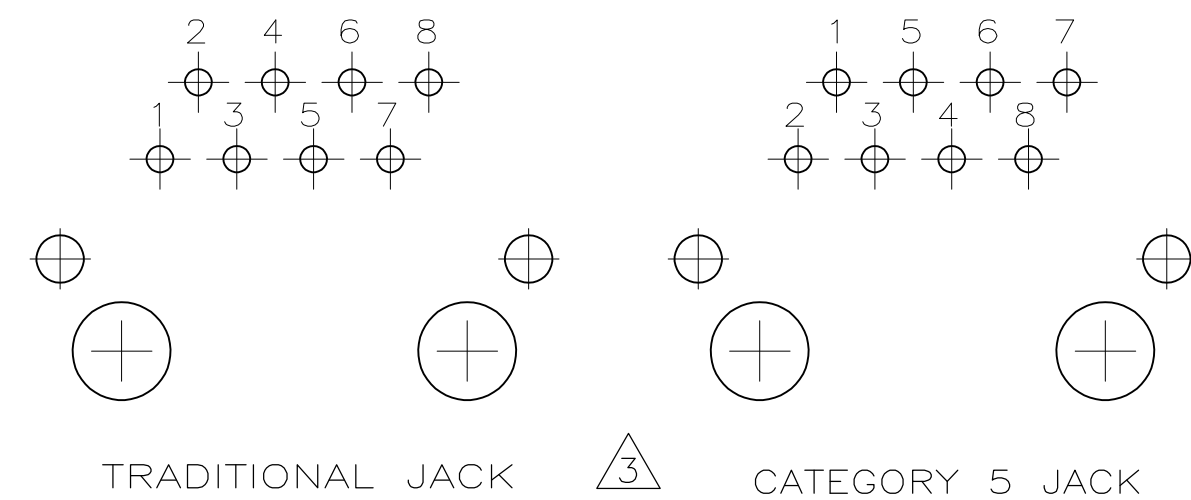
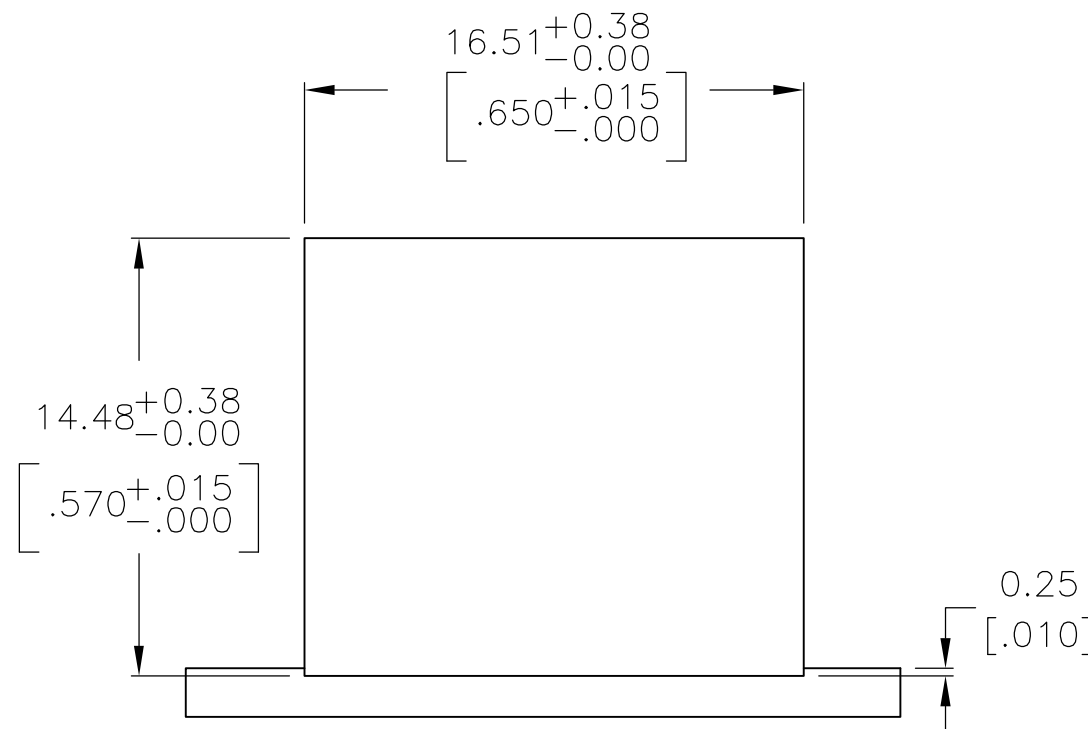
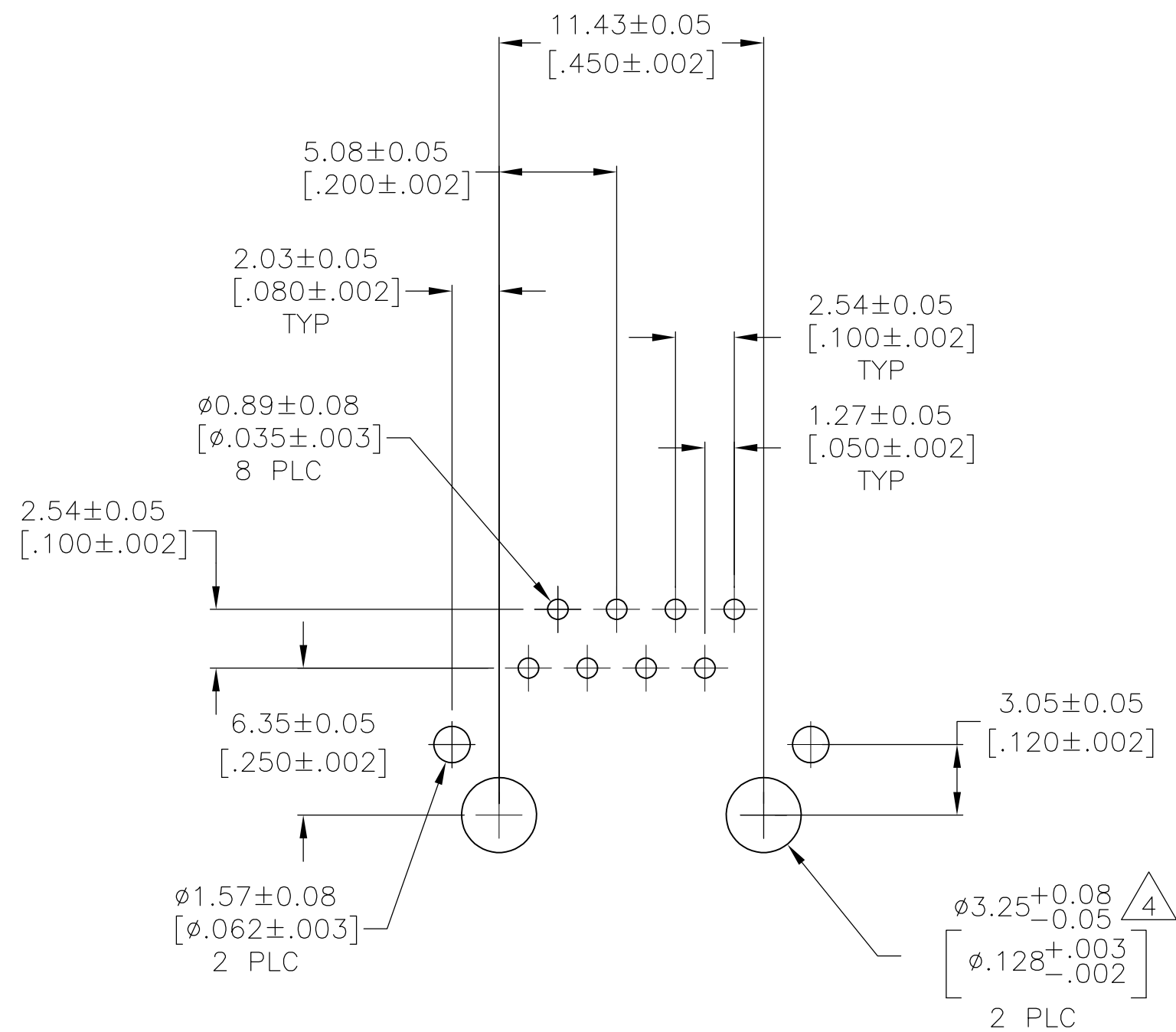


LOC	DIST	REVISIONS					
AA	00	P	LTR	DESCRIPTION	DATE	DWN	APVD
			B2	REVISED PER ECO-11-005033	28MAR11	RK	HMR



- 1 MATERIAL: HOUSING HIGH TEMPERATURE NYLON, BLACK, IR COMPATIBLE, UL 94V-0.
- TERMINALS - 0.33[.013] THICK PHOS BRONZE PLATED WITH 1.27 μ m[.000050] MINIMUM THICK HARD GOLD IN LOCALIZED AREA AND 3.81 μ m [0.000150] MINIMUM THICK MATTE TIN IN SOLDER AREA OVER 1.27 μ m[.000050] MINIMUM THICK NICKEL UNDERPLATE.
- SHIELDS - 0.254[.010] THICK COPPER ALLOY PLATED WITH 1.27 μ m[.000050] MINIMUM NICKEL AND 2.03 μ m [.000080] HOT TIN DIP ON PCB GROUND TABS.
- 2 JACK CAVITY CONFORMS TO FCC RULES AND REGULATIONS, PART 68 SUBPART F.
- 3 CAUTION: CATEGORY 5 JACK SOLDER TAIL POSITIONS DO NOT FOLLOW SAME NUMBER SEQUENCE AS THAT OF TRADITIONAL JACKS.
- 4 USE #30 DRILL BIT OR 3.25mm DRILL BIT WHEN PRODUCING THESE PCB HOLES.



SUGGESTED PANEL CUTOUT

SUGGESTED PC BOARD LAYOUT
COMPONENT SIDE

THIS DRAWING IS A CONTROLLED DOCUMENT.		DWN T. PITTS/L.A.MAYER 08JUNE2005		 TE Connectivity			
		CHK J.WESTMAN 08JUNE2005					
DIMENSIONS: mm		TOLERANCES UNLESS OTHERWISE SPECIFIED: 0 PLC ± - 1 PLC ± - 2 PLC ± 0.25[.010] 3 PLC ± - 4 PLC ± - ANGLES ± -		NAME MODULAR JACK ASSEMBLY, 8 POSITION, RIGHT ANGLE,LOW PROFILE,SHIELDED, PANEL GROUND, CATEGORY 5			
		APVD S.FLICKINGER 08JUNE2005					
		PRODUCT SPEC 108-1163					
		APPLICATION SPEC 114-2048					
MATERIAL		WEIGHT —		SIZE A2	CAGE CODE 00779	DRAWING NO C-5558344	RESTRICTED TO —
SEE NOTE 1		SEE NOTE 1		CUSTOMER DRAWING			
				SCALE 2:1		SHEET 1 of 1	
						REV B2	